

C1808C183KBGACTU

Aliases (C1808C183KBGAC7800)

SMD Comm C0G HV, Ceramic, 0.018 uF, 10%, 630 VDC, C0G, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1808



Click here for the 3D model.

Dimensions	
Chip Size	1808
L	4.7mm +/-0.5mm
W	2mm +/-0.2mm
Т	2mm +/-0.15mm
В	0.6mm +/-0.35mm

Packaging Specifications		
Packaging	T&R, 180mm, Plastic Tape	
Packaging Quantity	1000	

General Information		
Series	SMD Comm COG HV	
Style	SMD Chip	
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I	
Features	Ultra-Stable, Low Loss, Class I	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Component Weight	81 mg	
Shelf Life	78 Weeks	
MSL	1	

Specifications	
Capacitance	0.018 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	630 VDC
Dielectric Withstanding Voltage	819 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	55.5556 GOhms

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